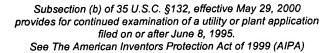


S&H Form: PTO/SB/30 (2/01)

REQUEST FOR CONTINUED EXAMINATION (RCE)

TRANSMITTAL

(INCLUDING FILING FEE AND/OR PETITION FOR **EXTENSION OF TIME FEE)**





	Subsection (b) of 35 U.S.C. §132 provides for continued examination of filed on or after Jui See The American Inventors Prot	PECEIVED MAY 27 2003 TC 1700			
To: Commissioner for Patents Box RCE PO Box 1450 Alexandria, VA 22313-1450		Attorney Docket No.:122.1457			
First Named Inventor	Nawalage Florence COORAY				
Application No.	09/892,608	Group Art Unit	1711		
Filing Date	June 28, 2001	Examiner	Travis B. Ribar		
CPA Filing Date		Confirmation No	4846		
Title of Invention	THERMOSETTING FLUORINATED DIELECTRICS AND MULTILAYER CIRCUIT BOARDS				

This is a Request for Continued Examination (RCE) under 37 C.F.R. §1.114 of the above-identified application.

NOTE: 37 C.F.R. §1.114 is effective on May 29, 2000. If the above-identified application was filed prior to May 29, 2000, applicant may wish to consider filing a continued prosecution application (CPA) under 37 C.F.R. §1.53(d) (PTO/SB/29) instead of a RCE to be eligible for the patent term adjustment provisions of the AIPA. See Changes to Application Examination and Provisional Application Practice, Interim Rule, 65 Fed. Reg. 14865 (March 20, 2000), 1233 Off. Gaz. Pat. Office 47 (Apr. 11, 2000), which established RCE practice.

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ii. 🔲 Consi	der the arguments in the Appeal Brief or Reply Brief previously filed on
iii. ☐ Other b. 🛛 Enclose	i
	iminary Amendment avit(s)/Declaration(s)
iii. 🔲 Infor	mation Disclosure Statement (IDS)
iv. ☐ Othe	r
liscellaneous	

02 FC:1253

05/23/2003 MDAMTE1 00000053 09892608

05/23/2003 HDAMTE1 00000053 09892608

01 FC:1801

750.00 OP

930.00 OP

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		BASIC	FEE	\$	750.00
Since a Notice	of Appeal was filed on	January 2, 2003, set	tting a two-		
	or reply, petition is here				
until June 2, 2003 to cover the date this RCE is filed, for which the					
requisite fee is enclosed (1 month (\$110); 2 months (\$410); 3 months					930.00
(\$930); 4 mont	ths (\$1,450); 5 months ((\$1,970)):			
Suspension Fe	ee (\$130.00)				
Total	\$	1,680.00			
Reduction by 50% for					
	TOTAL FEES DUE =	=		\$	1,680.00
4. Small	entity status:				
	Verified Statement Cl	aiming Small Entity S	Status.		
b. 🗌	A Verified Statement	Claiming Small Entit	y Status was p	previously filed	and such
	status is still proper ar	nd desired.			
c. 🔲	is no longer claimed.				
5. 🗌 Other	•				
6. METHOD	OF PAYMENT				
A chec	k in the amount of \$ \$1,	68000 is enclosed			
	"TOTAL FEES DUE" to	o Deposit Account N	o. 19-3935. (/	A duplicate copy of t	his form is
enclosed.					
	L AUTHORIZATION				
The Comm	issioner is hereby authorized to (R. 1.17 (processing fees) during t	credit any overpayment or cl	narge any additiona	al fees under 37 C.F.	.R. 1.16 (filing fees)
hereof purs	suant to 35 U.S.C. §120 to maint	ain pendency hereof and of	any such related ap	oplication to:	bidining benefit
	Account No. 19-3935				
8. CORRES	PONDENCE ADDRES	SS			
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NAME	William F. Herbert	_	REGISTRATION	ON NO. 31,	,024
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SIGNATURE	1	7	DATE	1/00	
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Docket No.: 122.1457

HENDITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 1711

Examiner: Travis B. Ribar

In re the Application of:

Nawalage Florence COORAY

Serial No. 09/892,608

Confirmation No. 4846

Filed: June 28, 2001

For:

Julie 20, 200 i

THERMOSETTING FLUORINATED DIELECTRICS AND MULTILAYER CIRCUIT

BOARDS

PRELIMINARY AMENDMENT

Commissioner for Patents and Trademarks Washington, D.C. 20231

Sir:

In addition to the December 6, 2002 Response, reconsideration is respectfully requested based on the following amendments and remarks.

I. REMARKS

A. In the Claims

Please ADD the following new claims 9-15 as follows:

- 9. (NEW) A method for forming a dielectric film on a circuit board, comprising the steps of:
- (a) reacting an o-aminophenol compound precursor with an aromatic dicarboxylic acid compound precursor, both of which precursors are one of mono- and poly-fluorinated, to form a fluorinated o-aminophenol polymer or oligomer;
- (b) introducing only thermosetting reactive groups at ends of the fluorinated oaminophenol polymer or oligomer to form a thermally curable fluorinated o-aminophenol polymer or oligomer precursor;
 - (c) dissolving the thermally curable fluorinated o-aminophenol polymer or oligomer